

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mark Kenneth Hoffmeyer et al. Art Unit: Unknown
Serial No.: FILED HEREWITH Examiner: Unknown
Filed: August 8, 2001 Atty. Docket No.: IBM/145DV1
For: PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS
COVERS ON AREA ARRAY BONDING SITES

PRELIMINARY AMENDMENT

BOX PATENT APPLICATION
Assistant Commissioner for Patents
Washington, DC 20231

Sir:

Please amend the above-identified patent application as follows, and prior to calculating the filing fees therefor:

Amendments

In the Specification

At page 1, after the title, please insert the following paragraph:

This application is a divisional of U.S. Patent Application Serial No. 09/606,583, filed on June 29, 2000 by Mark Kenneth Hoffmeyer et al. and entitled "PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS COVERS ON AREA ARRAY BONDING SITES," the disclosure of which is incorporated by reference herein.

In the Claims

Please cancel claims 1-10 and 13-18 without prejudice.

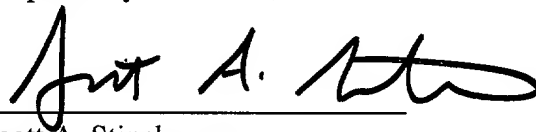
Remarks

The above-identified amendments to the specification are being made to provide information regarding the parent application.

The above-identified amendments to the claims are being made prior to calculation of the filing fees for the above-identified patent application. The claims currently pending after the above amendments are now claims 11-12 and 19-22. Applicants respectfully submit that no new matter is being added by the above amendments, as the amendments are fully supported in the specification, drawings and claims as originally filed. Attached hereto is a marked-up version of the changes made to the claims by the current amendment. The attachment is captioned "Version with Markings to Show Changes Made."

If there are any questions regarding this paper, or which might otherwise further this case onto allowance, please contact the undersigned at (513) 241-2324. Moreover, if any other charges or credits are necessary to complete this communication, please apply them to Deposit Account 23-3000.

Respectfully submitted,



Scott A. Stinebruner
Reg. No. 38,323
WOOD, HERRON & EVANS, L.L.P.
2700 Carew Tower
441 Vine Street
Cincinnati, Ohio 45202
(513)241-2324

8 AUG 2001

Date

Version with Markings to Show Changes Made

The specification has been amended as follows:

At page 1, after the title, the following paragraph has been inserted:

--This application is a divisional of U.S. Patent Application Serial No. 09/606,583, filed on June 29, 2000 by Mark Kenneth Hoffmeyer et al. and entitled "PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS COVERS ON AREA ARRAY BONDING SITES," the disclosure of which is incorporated by reference herein.--

The claims have been amended as follows:

Claims 1-10 and 13-18 have been canceled.

Claims 11-12 and 19-22 remain and are currently pending as follows:

11. An assembly comprising:

a circuit board;

an area array bonding site on a surface of the circuit board; and

a protective cover overlaying the bonding site, the protective cover removably registered to the bonding site by a plurality of posts secured to one of the protective cover and the circuit board into a plurality of apertures disposed in the other of the protective cover and the circuit board.

12. The assembly of claim 11, wherein the protective cover includes an adhesiveless surface contacting the bonding site.

19. A cover for protecting an area array bonding site on a surface of a circuit board, the circuit board having a plurality of apertures, the cover comprising:

a base member having a first face and second face, the base member shaped to at

1 least correspond to said area array bonding site; and

2 a plurality of posts coupled to the first face and registered for said plurality of
3 apertures.

1 20. The cover of claim 19, wherein the first face of the base member further includes
2 a recess corresponding to said area array bonding site.

1 21. The cover of claim 19, further comprising:

2 a graspable extension coupled to the second face of the base member.

1 22. The cover of claim 19, wherein each of the plurality of posts includes a diametral
2 slot.